Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

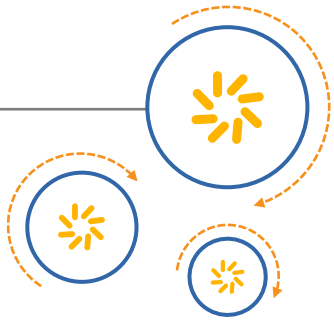
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

RF360 Europe GmbH

A Qualcomm – TDK Joint Venture



SAW Components

SAW IF filter

Basestation

Series/type:	B5235
Ordering code:	B39141B5235Z810
Date:	Sep 23, 2011
Version:	2.0

RF360 products mentioned within this document are offered by RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the “RF360 Subsidiaries”). RF360 Holdings Singapore Pte. Ltd. is a joint venture of Qualcomm Global Trading Pte. Ltd. and EPCOS AG. References in this documentation to EPCOS AG should properly reference, and shall be read to reference, the RF360 Subsidiaries.

RF360 Europe GmbH, Anzinger Str. 13, München, Germany

SAW Components

SAW IF filter

Basestation

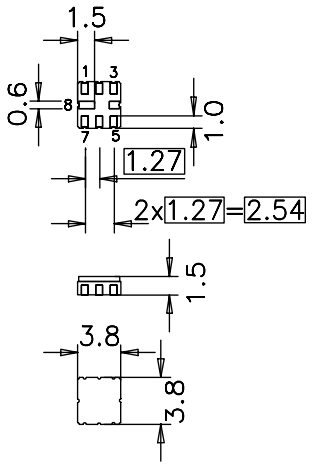
Series/type:	**B5235**
Ordering code:	**B39141B5235Z810**
Date:	Sep 23, 2011
Version:	2.0

Application

- Low-loss IF filter for basestation
- Usable passband 40 MHz

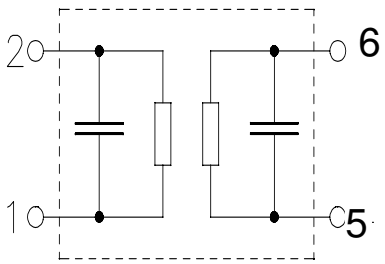
Features

- Package size 3.8 x 3.8 x 1.5 mm^3
- Package code QCC8B
- RoHS compatible
- Approx. weight 0.07g
- Ceramic package for **S**urface **M**ount **T**echnology (**SMT**)
- Ni, gold-plated terminals
- **E**lectrostatic **S**ensitive **D**evice (**ESD**)
- Filter Surface Passivated
- Moisture Sensitive Level 1



Pin configuration

1	Input
2	Input ground or return
5	Output
6	Output ground or return
3,4, 7,8	Package ground

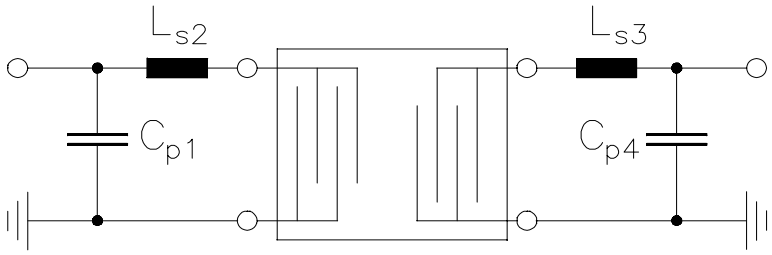


Characteristics

Operating temperature range: T = –40 ˚C to +85 ˚C
Terminating source impedance: Z_S = 50 Ω and matching network
Terminating load impedance: Z_L = 50 Ω and matching network

		min.	typ. @ 25 ˚C	max.	
Nominal frequency	f_N	—	140.0	—	MHz
Minimum insertion attenuation (including matching network)	α_{min}	—	10.8	12.5	dB
Amplitude ripple (p-p)	$\Delta\alpha$				
$f_N \pm 20$ MHz		—	2.0	2.5	dB
Group delay ripple (p-p)	$\Delta\tau$				
$f_N \pm 20$ MHz		—	77	100	ns
Absolute group delay					
$f_N \pm 20$ MHz	τ	—	0.27	0.5	µs
Absolute attenuation	α_{abs}				
From 10 MHz to 80 MHz		57.0	62.0	—	dB
From 80 MHz to 110 MHz		50.0	54.0	—	dB
From 110 MHz to 115 MHz		23.0	45.0	—	dB
From 170 MHz to 180 MHz		40.0	43.0	—	dB
From 180 MHz to 200 MHz		47.0	50.0	—	dB
From 200 MHz to 1 GHz		60.0	65.0	—	dB
Return loss, input $f_N \pm 20$ MHz		4.0	7.0	—	dB
Return loss, output $f_N \pm 20$ MHz		4.0	6.0	—	dB
Temperature coefficient of frequency	TC_f		-75		ppm/K

Matching network to 50 Ω single ended / 50 Ω single ended

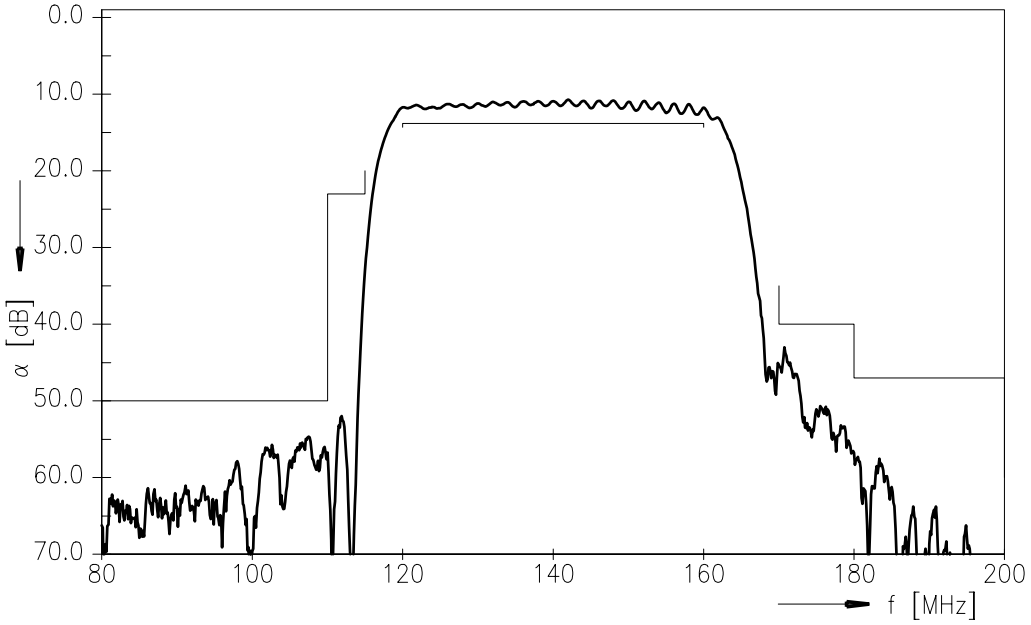


C_{p1} = 22 pF
L_{s2} = 110 nH
C_{p4} = 22 pF
L_{s3} = 110 nH

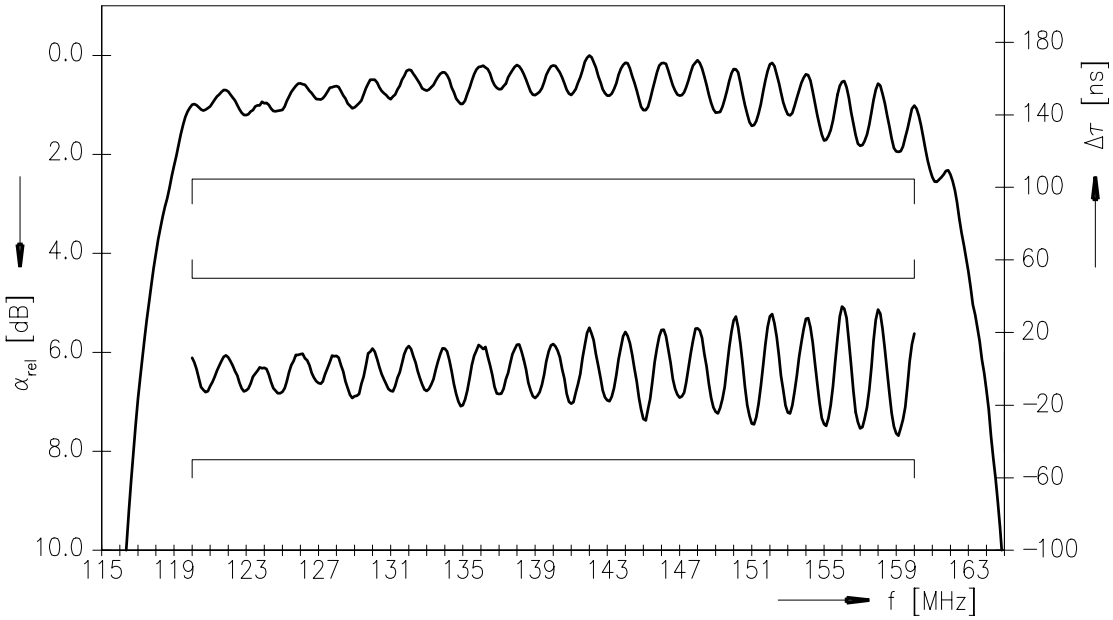
Maximum ratings

Operable temperature range	T	–40/+85	˚C	
Storage temperature range	T_{sta}	–40/+85	˚C	
DC voltage	V_{DC}	0	V	
Input power	P_{IN}	20	dBm	

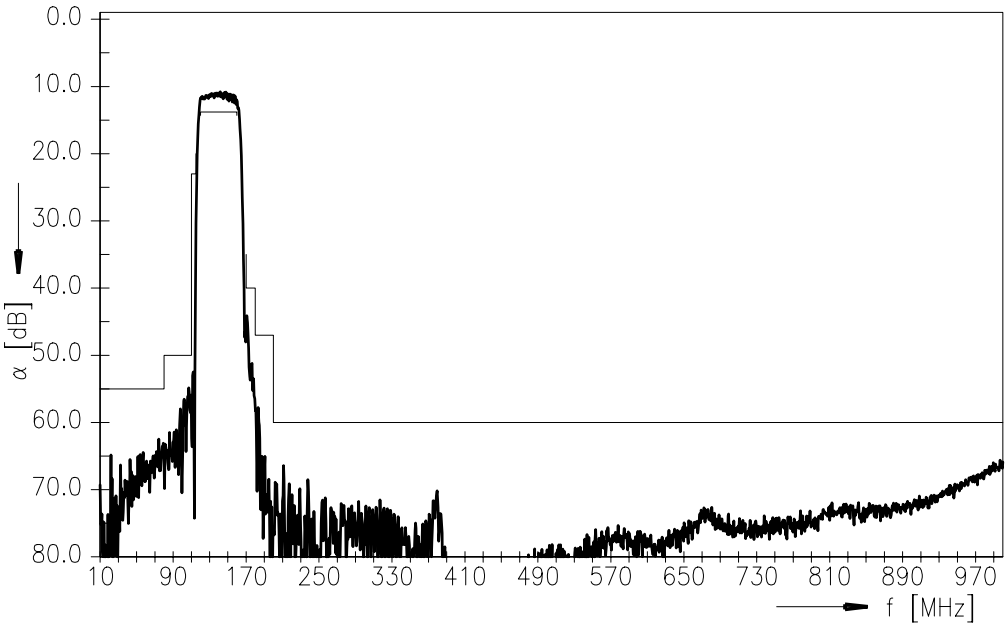
Transfer function



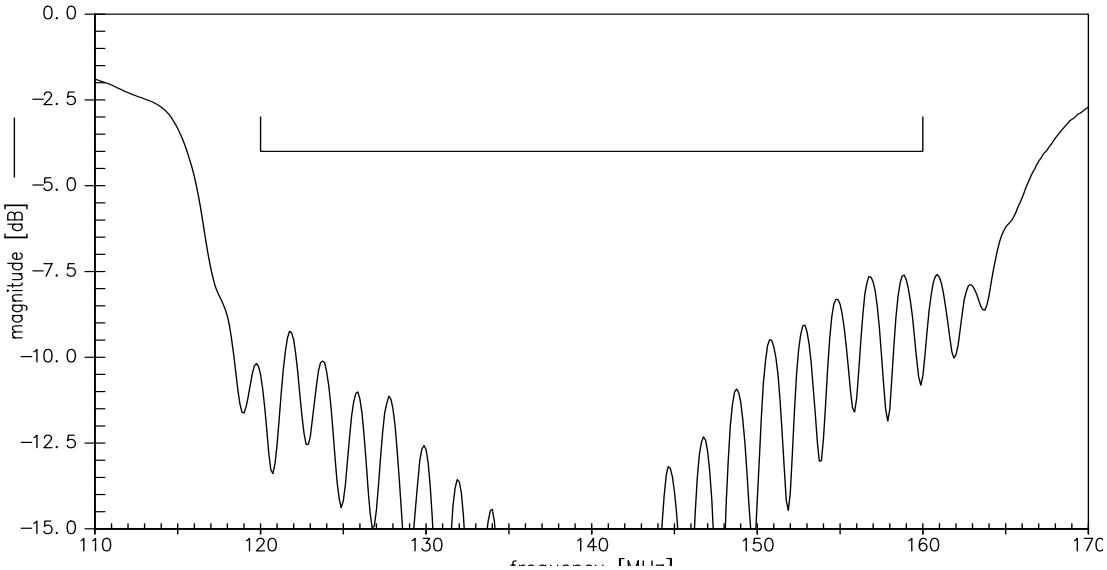
Transfer function (Passband)



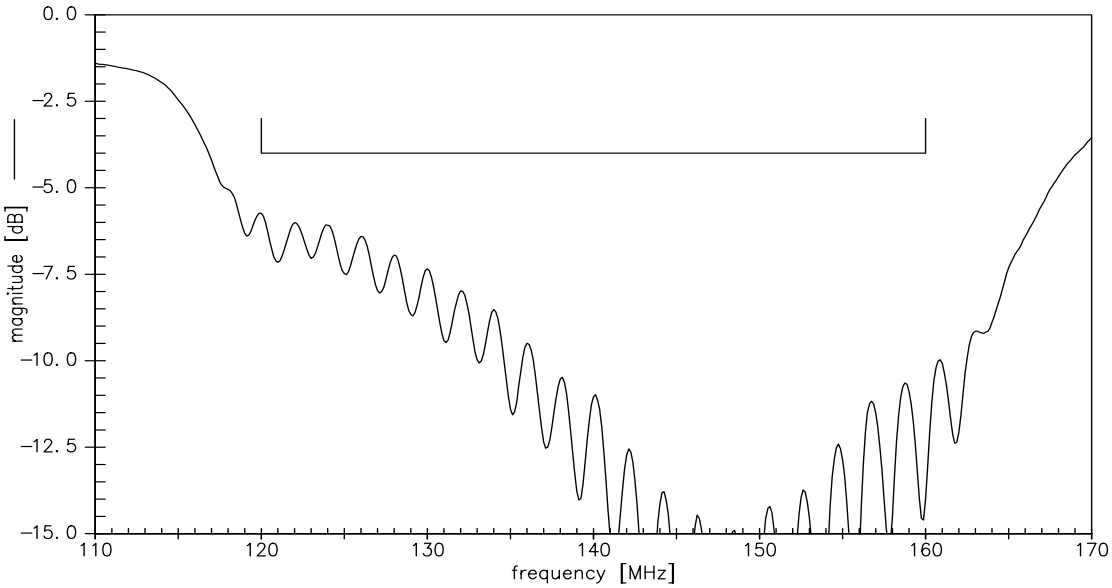
Transfer function (Wide band plot)



Input return loss



Output return loss



References

Type	B5235
Ordering code	B39141B5235Z810
Marking and package	C61157-A7-A46
Packaging	F61074-V8229-Z000
Date codes	L_1126
S-parameters	B5235_NB.S2P, B5235_WB.S2P
Soldering profile	S_6001
RoHS compatible	defined as compatible with the following documents: "DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment. 2005/618/EC from April 18th, 2005, amending Directive 2002/95/EC of the European Parliament and of the Council for the purposes of establishing the maximum concentration values for certain hazardous substances in electrical and electronic equipment."
Moldability	Before using in overmolding environment, please contact your EPCOS sales office.
Matching coils	See Inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm

For further information please contact your local EPCOS sales office or visit our webpage at www.epcos.com .

Published by EPCOS AG
Systems, Acoustics, Waves Business Group
P.O. Box 80 17 09, 81617 Munich, GERMANY

For questions on technology, prices and delivery please contact the Sales Offices of EPCOS AG or the international Representatives.

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our Sales Offices.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.
   We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
6. Unless otherwise agreed in individual contracts, **all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI)**.
7. The trade names EPCOS, BAOKE, Alu-X, CeraDiode, CSMP, CSSP, CTVS, DeltaCap, DigiSiMic, DSSP, FormFit, MiniBlue, MiniCell, MKD, MKK, MLSC, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SIP5D, SIP5K, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.epcos.com/trademarks.